



Product Qualification Report TP65H100G4PS

1. Purpose: The purpose of this specification is to document the Qualification Report for TP65H100G4PS
2. Scope
 - a. The products listed in section 1 are fully qualified and released to production.
 - b. Qualification test results on these products may reference existing qualification results of similar products per the use of generic data as defined in section 2.2 of AEC-Q101 Rev D1
 - c. Each of the referenced part numbers share the same major assembly process and material elements as defined in Stress Test qualification for Automotive Grade Semiconductors, AEC-Q101 and are considered to be part of the same qualification family.
3. Qualification Process
 - a. All Fab Lots were processed separately with a discrete amount of time between lots. All lots were assembled using the same Assembly House, on the same assembly line. All lots undergo Final Test using the documented test flow and are screened against documented test limits as appropriate to their part number. All processes and test conditions are documented and maintained under revision control as part of the Transphorm Quality Management System.
 - b. Documented process and test conditions that are used for qualification of products are designated "Process of Record". Changes to the Process of Record are managed through the Process/Product Change Notification Procedure, which is part of the Transphorm Quality Management System.
4. ESD Results: 3 parts pass for each test
 - a. Standard Used: ANSI/ESDA/JEDEC JS-001-2017

ESD TEST	RATING
CDM	$\geq 2000V / C3$
HBM	$>700V / 1B$

5. Reliability Testing
 - a. Failed devices are analyzed for root cause and correction. Only a representative sample needs to be analyzed, though some level of analysis will be applied to every failed part. Acceptable root cause and corrective action and successful demonstration of corrective and preventative actions will constitute successful qualification of a device. The part and/or qualification family can be qualified as long as containment of any problems is demonstrated until corrective and/or preventative actions are in place.



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6. Electrical Test Parameters

- a. Components submitted for qualification testing must meet all datasheet parameters before and after stress testing

Parameter	Symbol	Conditions	LSL	USL	Unit
Drain to source leakage current	I _{DSS}	V _{DS} = 650V V _{GS} = 0V T _J =25°C		25	μA
Gate to Source Forward Leakage Current	I _{GSS}	V _{GS} =20V		100	nA
Drain source on resistance	R _{DS}	V _{GS} = 10V I _D =12A T _J = 25°C		110	mΩ
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =1.8mA	3.2	4.1	V

7. Qualification Test Results

TEST	SYMBOL	CONDITIONS	SAMPLE	RESULT
High Temperature Reverse Bias	HTRB	T _J =150°C V _{DS} = 520V 1000 HRS	3 lots 77 parts per lot 231 total parts	0 Fails PASS
Highly Accelerated Temp and Humidity Test	HAST	130°C,85% RH 33.3 PSI Bias = 100V 96 HRS	3 lots 77 parts per lot 231 total parts	0 Fails PASS
Temperature Cycle	TC	-55°C / 150°C 2 Cycles / HR 1000 Cycles	3 lots 77 parts per lot 231 total parts	0 Fails PASS
Power Cycle	PC	25°C / 125°C ΔT = 100°C 7500 Cycles	3 lots 77 parts per lot 231 total parts	0 Fails PASS
High Temperature Gate bias	HTGB	150°C 1000 HRS V _{GSS} =20V	3 lots 77 parts per lot 231 total parts	0 Fails PASS
Solderability	SD	255°C/5Sec D&L	2 Lots 10 parts per lot 20 total parts	0 Fails PASS
Resistance to Solder Heat	RSH	THD: T=270°C T=7+2/-0 s	2 Lots 30 parts per lot 60 total parts	0 Fails PASS



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8. Referenced Documents

- a. AEC-Q101: Stress Test Qualification for Automotive Grade Discrete Semiconductors
- b. JESD47: Stress-Test Driven Qualification of Integrated Circuits
- c. MIL-PRF-38535: Performance specification-Integrated Circuits Manufacturing General Specification for Department of Defense
- d. JESD22-A108C: High Temperature Reverse Bias (HTRB)
- e. JESD22-A110D: Highly Accelerated Temperature and Humidity Stress Test (HAST)
- f. JESD22-A104D: Temperature Cycle (TC)
- g. JESD22-A122: Power Cycle (PC)
- h. JS-001-2012: Electrostatic Discharge Human Body Model
- i. J-STD-020D.1: Moisture/Reflow Sensitivity Classification
- j. JESD22-A102: Pre-conditioning

9. Signature Approval

A handwritten signature in blue ink that reads "Ronald Barr".

Ronald Barr
VP Quality

Transphorm